

## FEATURES

- Member of the Texas Instruments Widebus™ Family
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Output Port Has Equivalent 26-Ω Series Resistors, So No External Resistors Are Required
- Designed to Comply With JEDEC 168-Pin and 200-Pin SDRAM Buffered DIMM Specification
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages

NOTE: For tape-and-reel order entry, the DGG package is abbreviated to GR, and the DGV package is abbreviated to VR.

## DESCRIPTION

This 20-bit universal bus driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

Data flow from A to Y is controlled by the output-enable ( $\overline{OE}$ ) input. The device operates in the transparent mode when the latch-enable ( $\overline{LE}$ ) input is low. When  $\overline{LE}$  is high, the A data is latched if the clock (CLK) input is held at a high or low logic level. If  $\overline{LE}$  is high, the A data is stored in the latch/flip-flop on the low-to-high transition of CLK. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

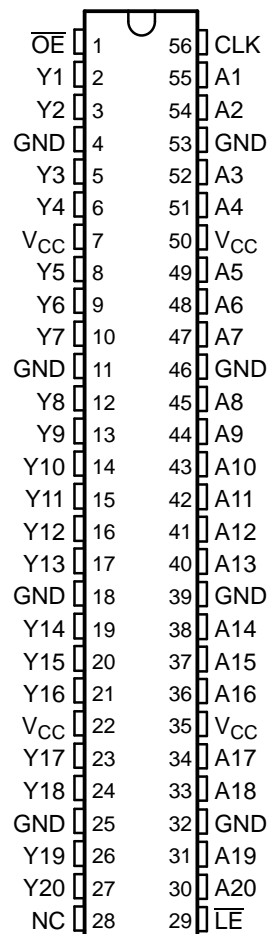
The output port includes equivalent 26-Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH162836 is characterized for operation from -40°C to 85°C.

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



NC – No internal connection



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

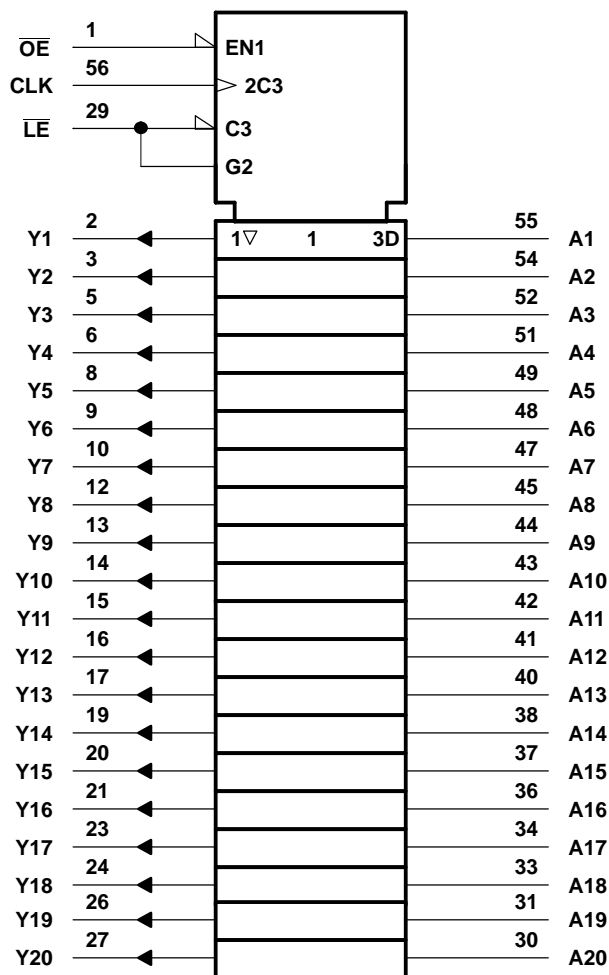
Widebus, EPIC are trademarks of Texas Instruments.

**FUNCTION TABLE**

| INPUTS          |                 |        |   | OUTPUT<br>Y |
|-----------------|-----------------|--------|---|-------------|
| $\overline{OE}$ | $\overline{LE}$ | CLK    | A |             |
| H               | X               | X      | X | Z           |
| L               | L               | X      | L | L           |
| L               | L               | X      | H | H           |
| L               | H               | ↑      | L | L           |
| L               | H               | ↑      | H | H           |
| L               | H               | L or H | X | $Y_0^{(1)}$ |

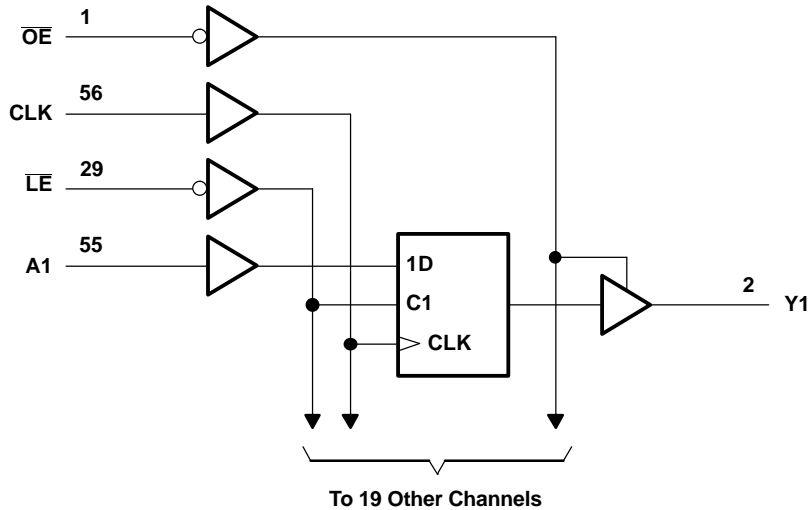
(1) Output level before the indicated steady-state input conditions were established

**LOGIC SYMBOL<sup>(1)</sup>**



(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

**LOGIC DIAGRAM (POSITIVE LOGIC)**



**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

|               |   | MIN         | MAX            | UNIT               |
|---------------|---|-------------|----------------|--------------------|
| $V_{CC}$      | Supply voltage range                            | -0.5        | 4.6            | V                  |
| $V_I$         | Input voltage range <sup>(2)</sup>              | -0.5        | 4.6            | V                  |
| $V_O$         | Output-voltage range <sup>(2)(3)</sup>          | -0.5        | $V_{CC} + 0.5$ | V                  |
| $I_{IK}$      | Input clamp current                             | $V_I < 0$   |                | -50 mA             |
| $I_{OK}$      | Output clamp current                            | $V_O < 0$   |                | -50 mA             |
| $I_O$         | Continuous output current                       |             |                | $\pm 50$ mA        |
|               | Continuous current through each $V_{CC}$ or GND |             |                | $\pm 100$ mA       |
| $\theta_{JA}$ | Package thermal impedance <sup>(4)</sup>        | DGG package |                | 81                 |
|               |   | DGV package |                | 86                 |
|               |   | DL package  |                | 74                 |
| $T_{stg}$     | Storage temperature range                       | -65         | 150            | $^{\circ}\text{C}$ |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) This value is limited to 4.6 V maximum.
- (4) The package thermal impedance is calculated in accordance with JESD 51.

**SN74ALVCH162836**  
**20-BIT UNIVERSAL BUS DRIVER**  
**WITH 3-STATE OUTPUTS**

SCES122F–JULY 1997–REVISED OCTOBER 2004

**RECOMMENDED OPERATING CONDITIONS<sup>(1)</sup>**

|                 |                                    | MIN                                | MAX                    | UNIT |
|-----------------|------------------------------------|------------------------------------|------------------------|------|
| V <sub>CC</sub> | Supply voltage                     | 1.65                               | 3.6                    | V    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.65 × V <sub>CC</sub> | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V   | 1.7                    |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   | 2                      |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.35 × V <sub>CC</sub> | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V   | 0.7                    |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   | 0.8                    |      |
| V <sub>I</sub>  | Input voltage                      | 0                                  | V <sub>CC</sub>        | V    |
| V <sub>O</sub>  | Output voltage                     | 0                                  | V <sub>CC</sub>        | V    |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 1.65 V           | -2                     | mA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V            | -6                     |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V            | -8                     |      |
|                 |                                    | V <sub>CC</sub> = 3 V              | -12                    |      |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 1.65 V           | 2                      | mA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V            | 6                      |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V            | 8                      |      |
|                 |                                    | V <sub>CC</sub> = 3 V              | 12                     |      |
| Δt/Δv           | Input transition rise or fall rate |                                    | 10                     | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     | -40                                | 85                     | °C   |

(1) All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                | TEST CONDITIONS  | V <sub>CC</sub>                         | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |
|--------------------------|--|---|-----------------------|--------------------|------|------|
| V <sub>OH</sub>          | I <sub>OH</sub> = -100 μA  | 1.65 V to 3.6 V                         | V <sub>CC</sub> - 0.2 |                    |      | V    |
|                          | I <sub>OH</sub> = -2 mA  | 1.65 V                                  | 1.2                   |                    |      |      |
|                          | I <sub>OH</sub> = -4 mA  | 2.3 V                                   | 1.9                   |                    |      |      |
|                          | I <sub>OH</sub> = -6 mA  | 2.3 V                                   | 1.7                   |                    |      |      |
|                          |  | 3 V                                     | 2.4                   |                    |      |      |
|                          | I <sub>OH</sub> = -8 mA  | 2.7 V                                   | 2                     |                    |      |      |
| I <sub>OH</sub> = -12 mA | 3 V  | 2                                       |                       |                    |      |      |
| V <sub>OL</sub>          | I <sub>OL</sub> = 100 μA   | 1.65 V to 3.6 V                         |                       |                    | 0.2  | V    |
|                          | I <sub>OL</sub> = 2 mA   | 1.65 V                                  |                       |                    | 0.45 |      |
|                          | I <sub>OL</sub> = 4 mA   | 2.3 V                                   |                       |                    | 0.4  |      |
|                          | I <sub>OL</sub> = 6 mA   | 2.3 V                                   |                       |                    | 0.55 |      |
|                          |  | 3 V                                     |                       |                    | 0.55 |      |
|                          | I <sub>OL</sub> = 8 mA   | 2.7 V                                   |                       |                    | 0.6  |      |
|                          | I <sub>OL</sub> = 12 mA  | 3 V                                     |                       |                    | 0.8  |      |
| I <sub>I</sub>           | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.6 V                                   |                       |                    | ±5   | μA   |
| I <sub>I(hold)</sub>     | V <sub>I</sub> = 0.58 V  | 1.65 V                                  | 25                    |                    |      | μA   |
|                          | V <sub>I</sub> = 1.07 V  | 1.65 V                                  | -25                   |                    |      |      |
|                          | V <sub>I</sub> = 0.7 V   | 2.3 V                                   | 45                    |                    |      |      |
|                          | V <sub>I</sub> = 1.7 V   | 2.3 V                                   | -45                   |                    |      |      |
|                          | V <sub>I</sub> = 0.8 V   | 3 V                                     | 75                    |                    |      |      |
|                          | V <sub>I</sub> = 2 V   | 3 V                                     | -75                   |                    |      |      |
|                          | V <sub>I</sub> = 0 to 3.6 V <sup>(2)</sup>                                   | 3.6 V                                   |                       |                    | ±500 |      |
| I <sub>OZ</sub>          | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.6 V                                   |                       |                    | ±10  | μA   |
| I <sub>CC</sub>          | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0                  | 3.6 V                                   |                       |                    | 40   | μA   |
| ΔI <sub>CC</sub>         | One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND | 3 V to 3.6 V                            |                       |                    | 750  | μA   |
| C <sub>i</sub>           | Control inputs   | V <sub>I</sub> = V <sub>CC</sub> or GND | 3.3 V                 |                    | 5.5  | pF   |
|                          | Data inputs  |   |                       |                    | 6    |      |
| C <sub>o</sub>           | Outputs  | V <sub>O</sub> = V <sub>CC</sub> or GND | 3.3 V                 |                    | 8    | pF   |

 (1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

(2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

**SN74ALVCH162836**  
**20-BIT UNIVERSAL BUS DRIVER**  
**WITH 3-STATE OUTPUTS**

SCES122F–JULY 1997–REVISED OCTOBER 2004

**TIMING REQUIREMENTS**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

|                    |                 | $V_{CC} = 1.8\text{ V}$                    |                 | $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | UNIT |  |
|--------------------|-----------------|--|-----------------|--|-----|-------------------------|-----|--|-----|------|--|
|                    |                 | MIN  | MAX             | MIN                                      | MAX | MIN                     | MAX | MIN                                      | MAX |      |  |
| $f_{\text{clock}}$ | Clock frequency | (1)  |                 | 150                                      |     | 150                     |     | 150                                      |     | MHz  |  |
| $t_w$              | Pulse duration  | $\overline{\text{LE}}$ low                 |                 | (1)                                      |     | 3.3                     |     | 3.3                                      |     | ns   |  |
|                    |                 | CLK high or low                            |                 | (1)                                      |     | 3.3                     |     | 3.3                                      |     |      |  |
| $t_{\text{su}}$    | Setup time      | Data before CLK $\uparrow$                 |                 | (1)                                      |     | 1.4                     |     | 1.7                                      |     | ns   |  |
|                    |                 | Data before $\overline{\text{LE}}\uparrow$ | CLK high        |  | (1) |                         | 1.2 |  | 1.6 |      |  |
|                    |                 |  | CLK low         |  | (1) |                         | 1.4 |  | 1.5 |      |  |
| $t_h$              | Hold time       | Data after CLK $\uparrow$                  |                 | (1)                                      |     | 0.9                     |     | 0.9                                      |     | ns   |  |
|                    |                 | Data after $\overline{\text{LE}}\uparrow$  | CLK high or low |  | (1) |                         | 1.1 |  | 1.1 |      |  |

(1) This information was not available at the time of publication.

**SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

| PARAMETER        | FROM (INPUT)           | TO (OUTPUT) | $V_{CC} = 1.8\text{ V}$ |     | $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | UNIT |
|------------------|------------------------|-------------|-------------------------|-----|--|-----|-------------------------|-----|--|-----|------|
|                  |                        |             | MIN                     | TYP | MIN                                      | MAX | MIN                     | MAX | MIN                                      | MAX |      |
| $f_{\text{max}}$ |                        |             | (1)                     |     | 150                                      |     | 150                     |     | 150                                      |     | MHz  |
| $t_{\text{pd}}$  | A                      | Y           | (1)                     |     | 1  | 4.4 | 4.6                     |     | 1.2                                      | 4   | ns   |
|                  | $\overline{\text{LE}}$ |             | (1)                     |     | 1.1                                      | 5.8 | 6.1                     |     | 1.4                                      | 5.1 |      |
|                  | CLK                    |             | (1)                     |     | 1  | 5.2 | 5.5                     |     | 1.1                                      | 5   |      |
| $t_{\text{en}}$  | $\overline{\text{OE}}$ | Y           | (1)                     |     | 1.1                                      | 6.4 | 6.5                     |     | 1.2                                      | 5.5 | ns   |
| $t_{\text{dis}}$ | $\overline{\text{OE}}$ | Y           | (1)                     |     | 1  | 4.7 | 5.2                     |     | 1.7                                      | 5.1 | ns   |

(1) This information was not available at the time of publication.

**OPERATING CHARACTERISTICS**

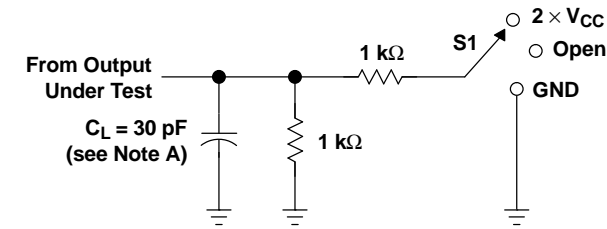
$T_A = 25^\circ\text{C}$

| PARAMETER       |                               | TEST CONDITIONS              | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V}$ | $V_{CC} = 3.3\text{ V}$ | UNIT |
|-----------------|-------------------------------|------------------------------|-------------------------|-------------------------|-------------------------|------|
|                 |                               |                              | TYP                     | TYP                     | TYP                     |      |
| $C_{\text{pd}}$ | Power dissipation capacitance | $C_L = 0, f = 10\text{ MHz}$ | (1)                     | 31.5                    | 36                      | pF   |
|                 | Outputs enabled               |                              | (1)                     | 8                       | 10.5                    |      |
|                 | Outputs disabled              |                              |                         |                         |                         |      |

(1) This information was not available at the time of publication.

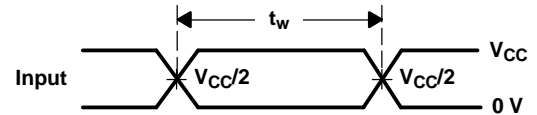
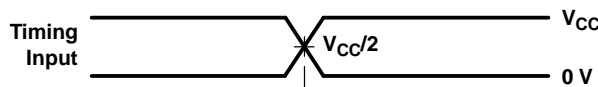
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 1.8\text{ V}$

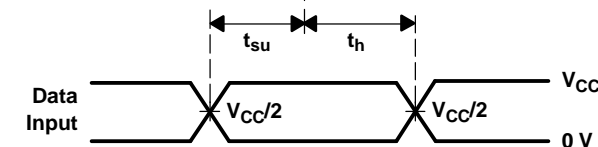


LOAD CIRCUIT

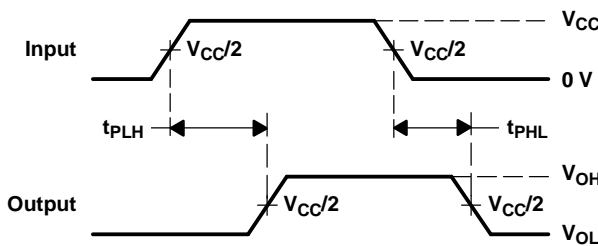
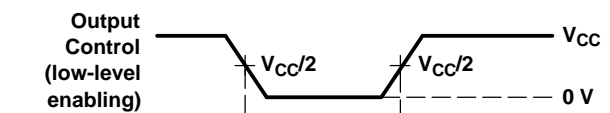
| TEST              | S1                |
|-------------------|-------------------|
| $t_{pd}$          | Open              |
| $t_{PLZ}/t_{PZL}$ | 2 $\times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |



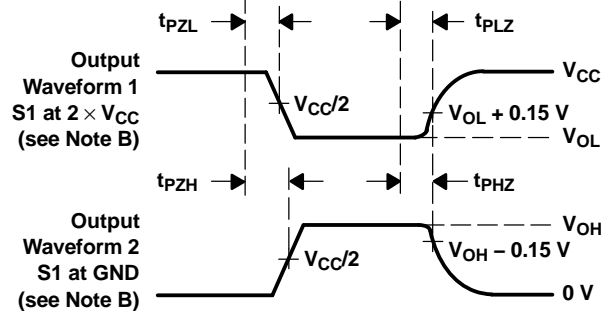
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



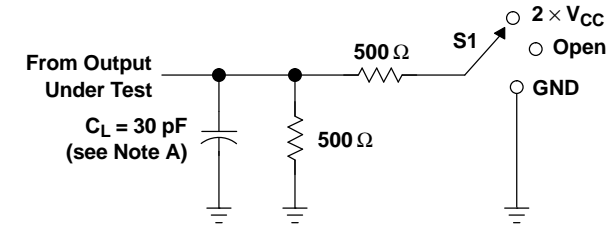
VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

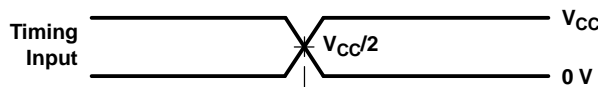
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

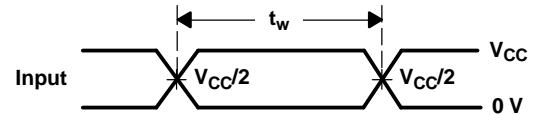


LOAD CIRCUIT

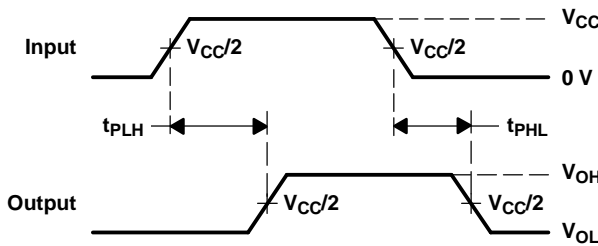
| TEST              | S1                |
|-------------------|-------------------|
| $t_{pd}$          | Open              |
| $t_{PLZ}/t_{PZL}$ | 2 $\times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |



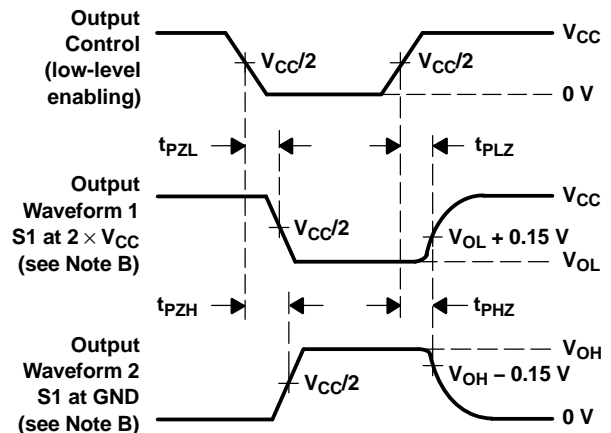
VOLTAGE WAVEFORMS  
 SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
 PULSE DURATION



VOLTAGE WAVEFORMS  
 PROPAGATION DELAY TIMES



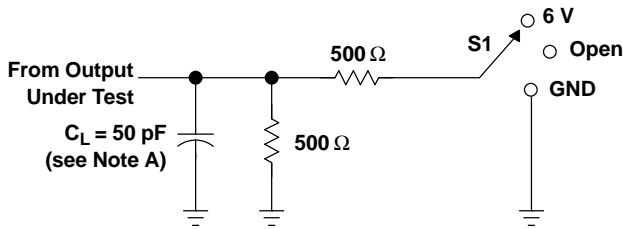
VOLTAGE WAVEFORMS  
 ENABLE AND DISABLE TIMES

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics: PRR  $\leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2 \text{ ns}$ ,  $t_f \leq 2 \text{ ns}$ .
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 2. Load Circuit and Voltage Waveforms

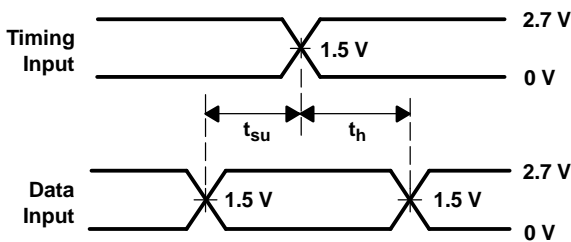
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.7\text{ V}$  AND  $3.3\text{ V} \pm 0.3\text{ V}$

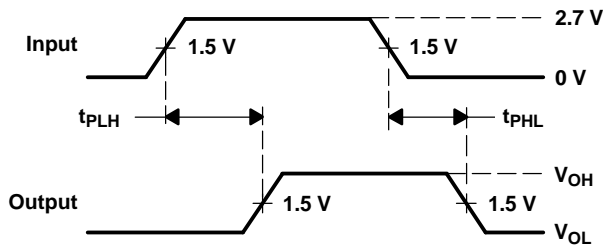


LOAD CIRCUIT

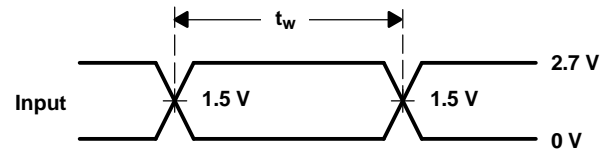
| TEST              | S1   |
|-------------------|------|
| $t_{pd}$          | Open |
| $t_{PLZ}/t_{PZL}$ | 6 V  |
| $t_{PHZ}/t_{PZH}$ | GND  |



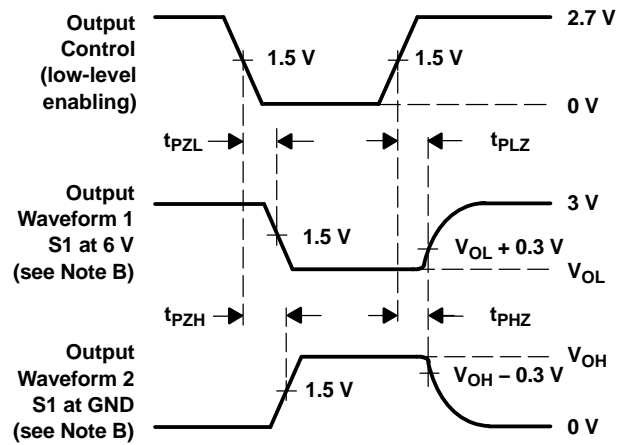
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 3. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|-------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| 74ALVCH162836GRE4 | ACTIVE        | TSSOP        | DGG                | 56   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ALVCH162836             | <a href="#">Samples</a> |
| SN74ALVCH162836GR | ACTIVE        | TSSOP        | DGG                | 56   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ALVCH162836             | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

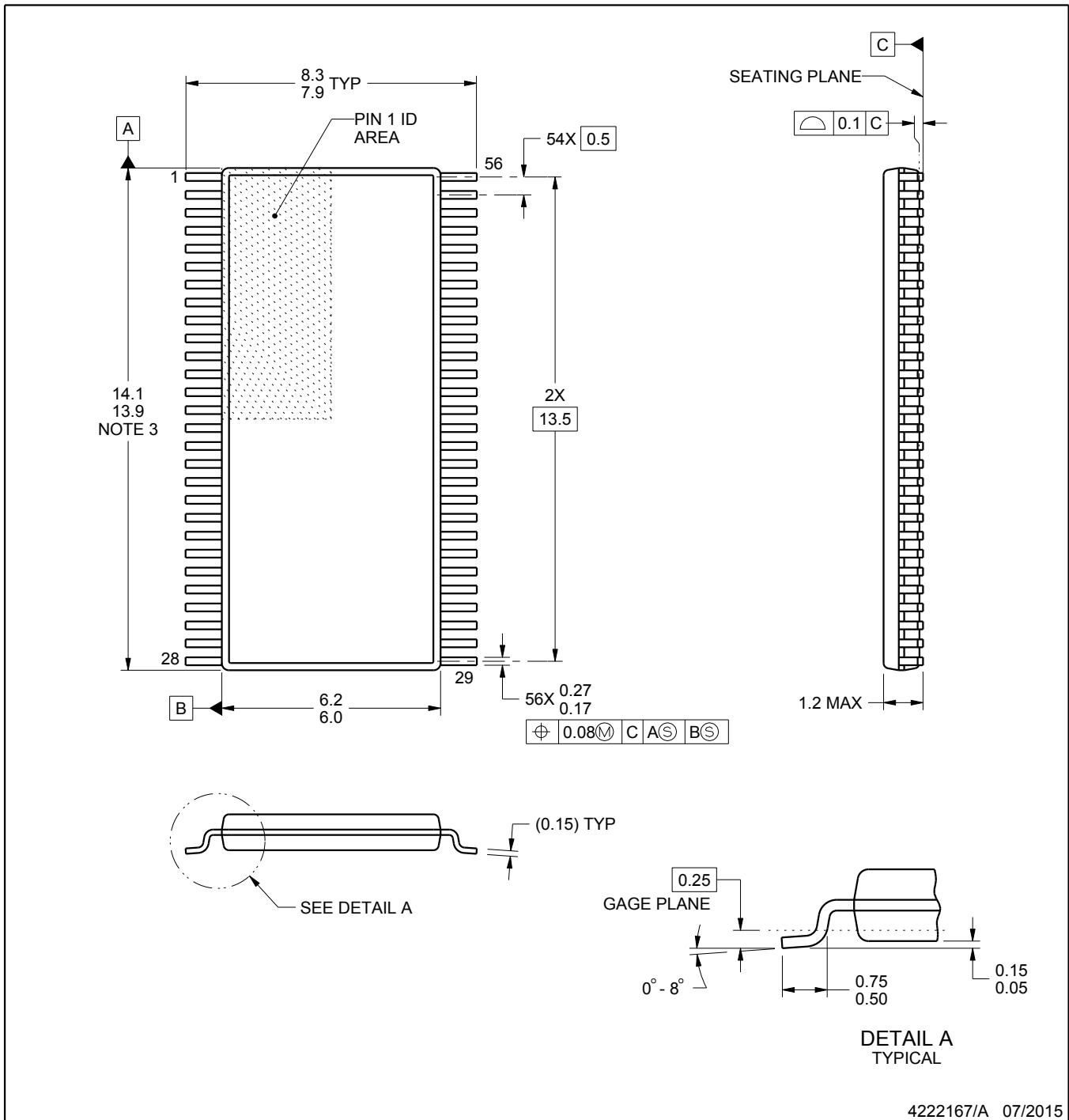
| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ALVCH162836GR | TSSOP        | DGG             | 56   | 2000 | 330.0              | 24.4               | 8.6     | 15.6    | 1.8     | 12.0    | 24.0   | Q1            |

TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ALVCH162836GR | TSSOP        | DGG             | 56   | 2000 | 367.0       | 367.0      | 45.0        |



4222167/A 07/2015

NOTES:

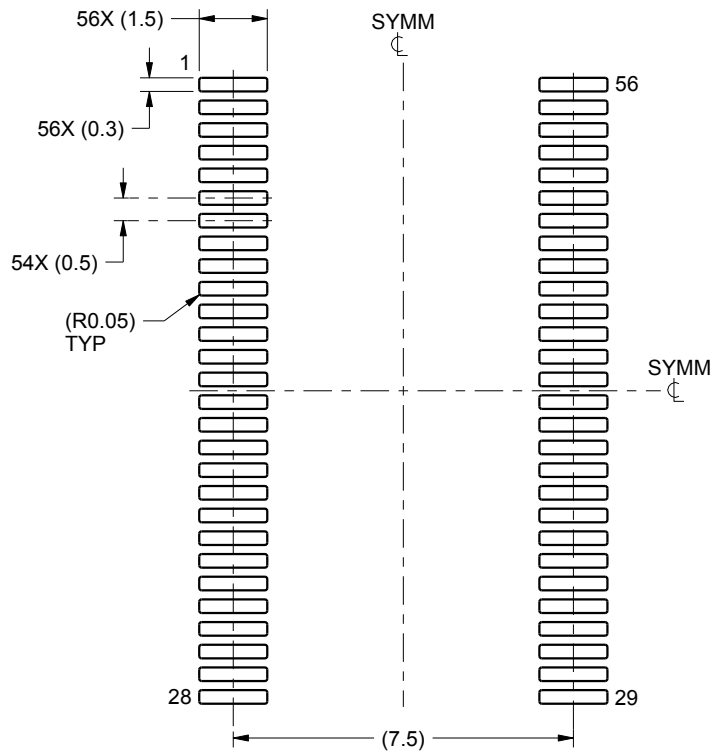
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

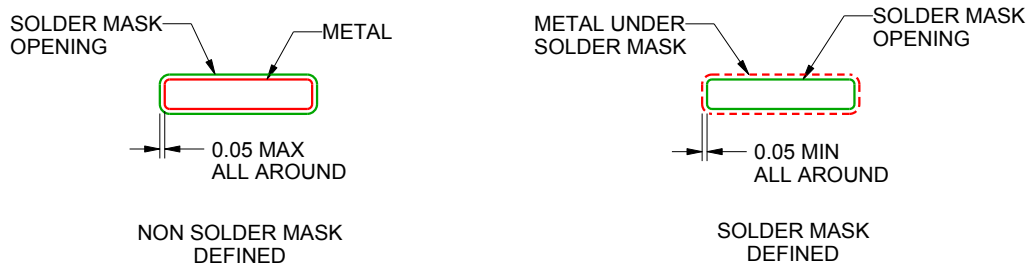
DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4222167/A 07/2015

NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4222167/A 07/2015

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (<https://www.ti.com/legal/termsofsale.html>) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2021, Texas Instruments Incorporated